

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S23	6141	((29/846,847,851) or (216/95,96,97,99,100,101,102,104,105,107,109)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/23 10:05
L3	0	L1 AND L2	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/23 08:41
L2	5	((pre\$1sinter\$4 OR sub\$1sinter\$4) SAME (conduct\$4 OR metal\$4) SAME (etch\$4 OR pattern) SAME (heat\$4 OR fir\$4 thermal\$4))	US-PGPUB	OR	OFF	2005/09/23 08:41
L1	5	((("6,353,189") or ("5,357,138") or ("6,000,120") or ("5,426,399") or ("5,317,292")).PN.	USPAT; USOCR	OR	OFF	2005/09/23 08:41
S54	5	((pre\$1sinter\$4 OR sub\$1sinter\$4) SAME (conduct\$4 OR metal\$4) SAME (etch\$4 OR pattern) SAME (heat\$4 OR fir\$4 thermal\$4))	US-PGPUB	OR	OFF	2005/09/23 08:40
S53	169	((pre\$1sinter\$4 OR sub\$1sinter\$4) AND (conduct\$4 OR metal\$4) AND (etch\$4 OR pattern) AND (heat\$4 OR fir\$4 thermal\$4))	US-PGPUB	OR	OFF	2005/09/22 18:21
S51	19	S42 AND ((metal\$4 OR conduct\$4) NEAR20 (organic\$4 NEAR20 (remov\$4 OR burn\$4)))	US-PGPUB	OR	OFF	2005/09/22 18:18
S43	50	S42 AND ((metal\$4 OR conduct\$4) NEAR20 (organic\$4 NEAR20 (remov\$4 OR burn\$4)))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:14
S50	3	S49 AND S43	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:13
S49	6346	((29/846,847,851) or (216/95,96,97,99,100,101,102,104,105,107,109)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:13
S48	0	S47 AND ((metal\$4 OR conduct\$4) NEAR20 (organic\$4 NEAR20 (remov\$4 OR burn\$4)))	EPO; JPO; DERWENT	OR	OFF	2005/09/22 18:13
S37	6285	((29/846,847,851) or (216/95,96,97,99,100,101,102,104,105,107,109)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:13
S47	506	S45 AND (ceramic OR di\$1electric OR insulat\$4)	EPO; JPO; DERWENT	OR	OFF	2005/09/22 18:12
S42	5322	S41 AND (ceramic OR di\$1electric OR insulat\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:12
S45	1603	S44 AND (micro\$1wave\$1 NEAR20 circuit\$4)	EPO; JPO; DERWENT	OR	OFF	2005/09/22 18:11

S41	6821	S39 AND (micro\$1wave\$1 NEAR20 circuit\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:11
S44	2763080	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	EPO; JPO; DERWENT	OR	OFF	2005/09/22 18:10
S39	2348369	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:10
S34	44	S33 AND ((metal\$4 OR conduct\$4) WITH (organic\$4 WITH (remov\$4 OR burn\$4)))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/09/22 18:04
S33	1910	S32 AND (ceramic OR di\$1electric OR insulat\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 18:03
S32	2032	S31 AND ((metal\$4 OR conduct\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 17:59
S31	6970	S30 AND (micro\$1wave\$1 WITH circuit\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 17:59
S30	2315017	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/09/22 17:43
S38	4	S34 AND S37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/07/07 11:05
S36	2	((("6420778") or ("20040023482")).PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/07/07 10:15
S28	42	S27 AND ((metal\$4 OR conduct\$4) WITH (organic\$4 WITH (remov\$4 OR burn\$4)))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/07/07 10:07
S29	3	S23 AND S28	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/27 14:53
S27	1799	S26 AND (ceramic OR di\$1electric OR insulat\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/27 14:44

S26	1918	S25 AND ((metal\$4 OR conduct\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/27 14:44
S25	6655	S24 AND (micro\$1wave\$1 WITH circuit\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/27 14:44
S24	2244561	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/27 14:44
S22	2	S18 AND ((HF WITH de\$1ioniz\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 15:03
S21	0	S18 AND ((HF WITH di\$1ioniz\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 15:03
S20	85	S18 AND ((HF) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 15:02
S19	283	S18 AND ((HF or acid) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 14:57
S18	1915	S17 AND ((metal\$4 OR conduct\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 14:34
S17	6648	S16 AND (micro\$1wave\$1 WITH circuit\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 14:34
S16	2241290	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 14:34
S6	1910	S2 AND ((metal\$4 OR conduct\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 14:33
S15	1	("20040258841").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:35
S8	42	S7 AND ((metal\$4 OR conduct\$4) WITH (organic\$4 WITH (remov\$4 OR burn\$4)))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:34
S14	4	((("3,808,042") or ("5,910,334") or ("6,255,730") or ("6,457,979")).PN.	USPAT; USOCR	OR	OFF	2005/01/21 08:15
S11	12	S10 AND ((metal\$4 OR conduct\$4) WITH (etch\$4 OR pattern\$4))	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:14
S13	2	("4303480").URPN.	USPAT	OR	OFF	2005/01/21 08:06

S12	1	("4303480").PN.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:03
S10	13	S9 AND (sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:01
S1	2239574	sub\$2sinter\$4 OR sinter\$4 OR (thermal\$2 ADJ3 treat\$4) OR heat\$4 OR anneal\$4 OR pre\$2heat\$4 OR pre\$2anneal\$4	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 08:01
S9	15	("4808274").URPN.	USPAT	OR	OFF	2005/01/21 08:00
S7	1791	S6 AND (ceramic OR di\$1electric OR insulat\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 07:53
S2	6637	S1 AND (micro\$1wave\$1 WITH circuit\$4)	US-PGPUB; USPAT; USOCR	OR	OFF	2005/01/21 07:46